

### TRUNK INTERFACE

- ON CHIP POLARITY GUARD
- MEETS DC LINE CHARACTERISTICS OF EITHER CCITT AND EIA RS 464 SPECS
- PULSE FUNCTION
- HIGH AC IMPEDANCE
- OFF HOOK-STATUS DETECTION OUTPUT
- LOW EXTERNAL COMPONENT COUNT

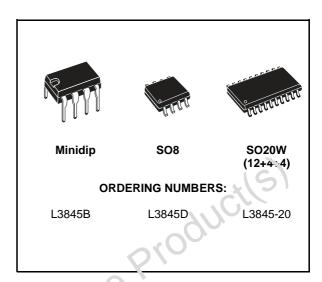
#### **DESCRIPTION**

The circuit provides DC loop termination for analog trunk lines.

The V-I characteristics is equivalent to a fixed voltage drop (zener like characteristic) in series with an external resistance that determines the slope of the DC characteristic.

An external low voltage electrolytic capacitor causes the circuit to exhibit a very high impedance to all AC signal above a minimum frequency that is determined by the capacitor itself and by a 20 K nominal resistor integrated on the chip.

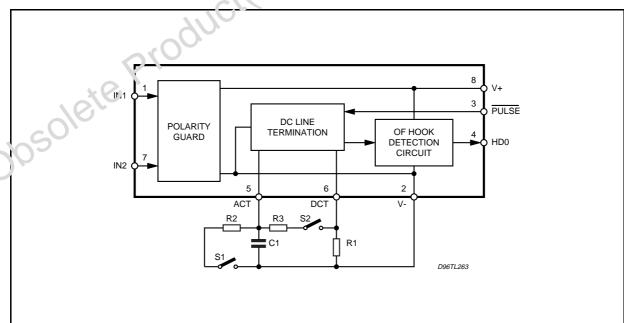
The Off-Hook status is detected all the time a typic of 8 mA is flowing into the circuit. In this condition a constant current generator is activated to



supply an external device (typically an optocoupler) with our affecting the AC characteristic of the circuit.

When Fulse Dialing is required the PULSE input (pir 3) connected to V- causes the device to reduce the fixed DC voltage drop and to exhibit a pure resistive impedance equal to the external resistor.

#### **BLOCK DIAGRAM**

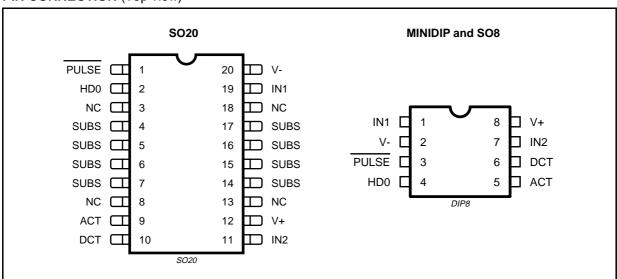


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#### **ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Value	Unit
$V_{L}$	Max Line Voltage (pulse duration 10 ms max)	20	V
lμ	Max Line Current	150	mA
P <sub>tot</sub>	Total Power Dissipation at Tamb = 70 °C	800	mW
T <sub>op</sub>	Operating Temperature	- 40 to + 70	°C
T <sub>srg</sub> , T <sub>j</sub>	Storage and Junction Temperature	- 55 to + 150	°C

### PIN CONNECTION (Top view)



SUBS = the pin is electrically and thermally in good contact with the chip sustrate. Connect to PCB copper tracks, for heat dissipation the tracks shall preferably be electrically connected to pin 20 (internally bonded to the chip substrate) or left floating. A higher track density and/or area assures a R<sub>th j-amb</sub> towards the lower limit.

### THERMAL DATA

Symbol	Parameter		Minidip	SO8	SO20	Unit
R <sub>th j-amb</sub>	Thermal Resistance Junction-ambient (*)	Max.	80	140 to 180	50 to 70	°C/W

(\*) Mounted on FR4 Boards

**DC ELECTRICAL CHARACTERISTICS** ( $I_L = 10 \text{ mA}$  to 100 mA,  $R_1 = 56 \Omega$ ,  $S_1 = \text{Open}$ ,  $T_{amb} = +25 \,^{\circ}\text{C}$ , unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit
V <sub>L</sub>	Line Voltage (normal mode)	PULSE = Open IL = 10 mA $I_L = 20$ mA $I_L = 100$ mA			5 6 12	V V V
V <sub>LP</sub>	Line Voltage (pulse mode)	PULSE = V <sup>-</sup> I <sub>L</sub> = 20 mA I <sub>L</sub> = 35 mA I <sub>L</sub> = 80 mA			4 5.5 9.5	V V V
I <sub>hn</sub>	ON/OFF-Hook Line Current Detection Threshold		6.5		9.5	mA
I <sub>hf</sub>	OFF/ON-Hook Line Current Detection Threshold		5		9.2	mA
l <sub>OUT</sub>	OFF-Hook Output Drive Current at Pin HDO	$IL = 10 \text{ mA}$ $I_L \ge 20 \text{ mA}$	1.5 1.8			mA mA
$V_{PM}$	Pulse Input Low Voltage				0.8	V
I <sub>PM</sub>	Pull-up Input Current at Pin PULSE (pulse mode)	IL = 100 mA Pulse = V <sup>-</sup>			20	μА
I <sub>NM</sub>	Imput Current at Pin Pulse (normal mode)				3	μΑ

## **AC ELECTRICAL CHARACTERISTICS** ( $I_L = 10 \text{mA}$ to 100 mA, $R_1 = 56 \Omega$ , $R_2 = 470 \text{K}\Omega$ , $R_3 = 130 \text{K}\Omega$ , $R_{amb} = +25 \,^{\circ}\text{C}$ , unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit
Z <sub>L</sub>	AC Line Impedance	$S_1 = \text{Open}, S_2 = \text{Open}$ $C_1 = 2.2\text{mF}$ f = 1KHz		20		ΚΩ
	Sending/Receiving Distortion	$S_1 = \text{Open}, S_2 = \text{Open}$ f = 1KHz $V_{AC-L} = 775\text{mVrms}$ $I_L = 15 \text{ to } 100\text{mA}$			2	%
	Sending/Receiving Distortion	$S_1$ = Closed; $S_2$ = Open $V_{AC-L}$ = 1.3 $V$ rms		2		%
	Sending/Receiving Distortion	$S_1$ = Open; $S_2$ = Closed $V_{AC-L}$ = 1.9Vrms		2(*)		%

<sup>(\*)</sup> Not tested, guaranteed only by design.

#### **APPLICATION INFORMATION**

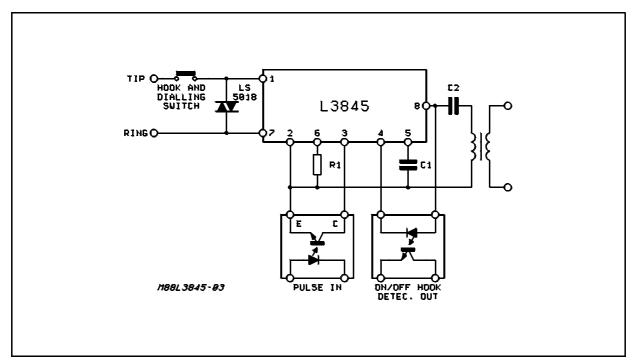
With the use of this circuit it is possible to terminate an analog trunk so that all the DC current component is flowing in the TRUNK TERMINATION CIRCUIT while the AC component is decoupled with a low voltage capacitor and can be used with a small and low cost audio coupler transformer to provide the AC balancing termination and two to four wire conversion.

Therefore it is usefull both for MODEM and PABX systems.

Figure 1 gives the typical application circuit; it is worth to note that the TRUNK TERMINATION CIRCUIT, together with the LS5018 transient suppressor provides a compact and low cost module fully protected against lightning or overvoltages frequently present on telephone lines.

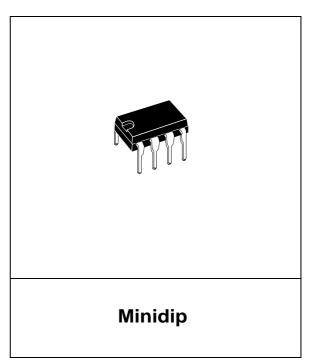
The PULSE input when connected to V- allows the device to reduce the Line Voltage and to show a resistive impedance equal to R1 to the line. When PULSE input is left open, this function is disable.

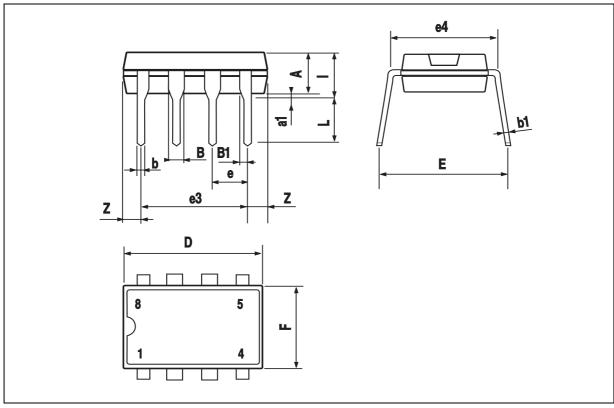
Figure 1: Typical Application.



DIM.	mm					
Dilvi.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
Α		3.32			0.131	
a1	0.51			0.020		
В	1.15		1.65	0.045		0.065
b	0.356		0.55	0.014		0.022
b1	0.204		0.304	0.008		0.012
D			10.92			0.430
Е	7.95		9.75	0.313		0.384
е		2.54			0.100	
e3		7.62			0.300	
e4		7.62			0.300	
F			6.6			0.260
I			5.08			0.200
L	3.18		3.81	0.125		0.150
Z			1.52			0.060

# OUTLINE AND MECHANICAL DATA

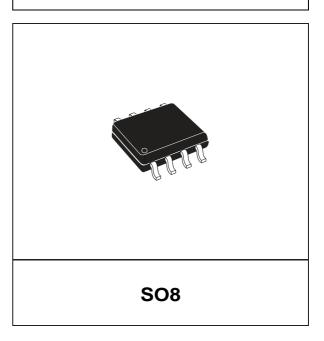


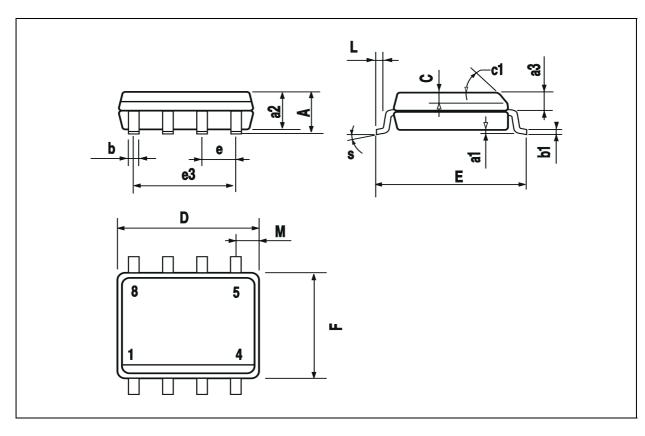


DIM.		mm			inch		
Dilvi.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
Α			1.75			0.069	
a1	0.1		0.25	0.004		0.010	
a2			1.65			0.065	
аЗ	0.65		0.85	0.026		0.033	
b	0.35		0.48	0.014		0.019	
b1	0.19		0.25	0.007		0.010	
С	0.25		0.5	0.010		0.020	
c1			45° (	(typ.)			
D (1)	4.8		5.0	0.189		0.197	
Е	5.8		6.2	0.228		0.244	
е		1.27			0.050		
еЗ		3.81			0.150		
F (1)	3.8		4.0	0.15		0.157	
L	0.4		1.27	0.016		0.050	
М			0.6			0.024	
S	8° (max.)						

### (1) D and F do not include mold flash or protrusions. Mold flash or potrusions shall not exceed 0.15mm (.006inch).

# OUTLINE AND MECHANICAL DATA

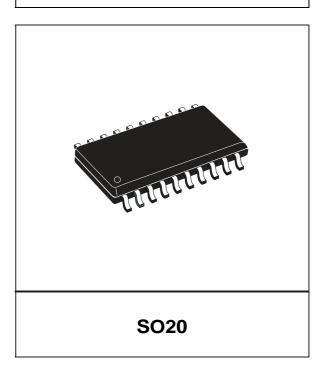


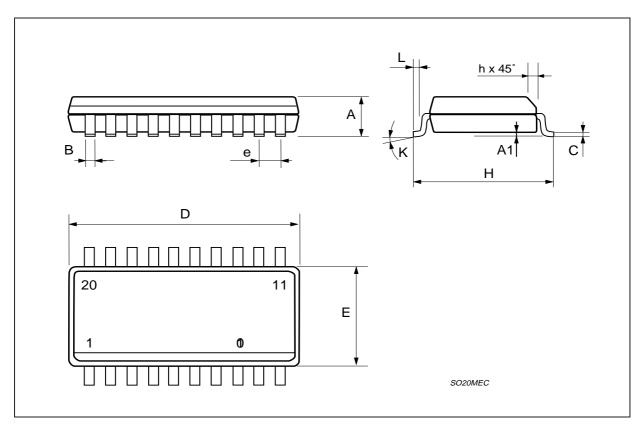


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DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
Α	2.35		2.65	0.093		0.104
A1	0.1		0.3	0.004		0.012
В	0.33		0.51	0.013		0.020
С	0.23		0.32	0.009		0.013
D	12.6		13	0.496		0.512
Е	7.4		7.6	0.291		0.299
е		1.27			0.050	
Н	10		10.65	0.394		0.419
h	0.25		0.75	0.010		0.030
L	0.4		1.27	0.016		0.050
K	0° (min.)8° (max.)					

# OUTLINE AND MECHANICAL DATA





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